TOSHIBA Field Effect Transistor Silicon P Channel MOS Type (U-MOS II)

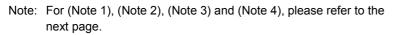
TPCS8101

Lithium Ion Battery Applications Portable Equipment Applications Notebook PCs

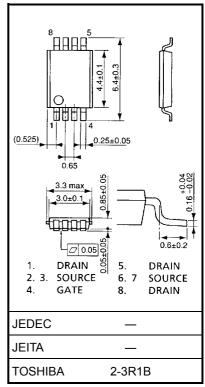
- Small footprint due to small and thin package
- Low drain-source ON resistance: R_{DS} (ON) = 15 m Ω (typ.)
- High forward transfer admittance: $|Y_{fs}| = 12 \text{ S} (typ.)$
- Low leakage current: $I_{DSS} = -10 \ \mu A \ (max) \ (V_{DS} = -30 \ V)$
- Enhancement-mode: $V_{th} = -0.8 \sim -2.0 \text{ V} (V_{DS} = -10 \text{ V}, \text{ ID} = -1 \text{ mA})$

Maximum Ratings (Ta = 25°C)

Characte	ristics	Symbol	Rating	Unit	
Drain-source voltage		V _{DSS}	-30	V	
Drain-gate voltage (R	R _{GS} = 20 kΩ)	V _{DGR}	-30	V	
Gate-source voltage		V _{GSS}	±20	V	
Drain current	DC (Note 1)	ID	-6	А	
Diameditent	Pulse (Note 1)	I _{DP}	-24	~	
Drain power dissipati	on (t = 10 s) (Note 2a)	PD	1.5	W	
Drain power dissipati	on (t = 10 s) (Note 2b)	PD	0.6	W	
Single pulse avalancl	ne energy (Note 3)	E _{AS}	46.8	mJ	
Avalanche current		I _{AR}	-6	A	
Repetitive avalanche	energy (Note 2a, Note 4)	E _{AR}	0.15	mJ	
Channel temperature		T _{ch}	150	°C	
Storage temperature	range	T _{stg}	−55 to 150	°C	

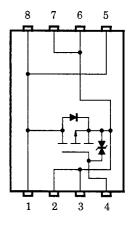


This transistor is an electrostatic sensitive device. Please handle with caution.



Weight: 0.035 g (typ.)

Circuit Configuration

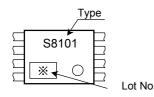


Unit: mm

Thermal Characteristics

Characteristics	Symbol	Max	Unit
Thermal resistance, channel to ambient (t = 10 s) (Note 2a)	R _{th (ch-a)}	83.3	°C/W
Thermal resistance, channel to ambient (t = 10 s) (Note 2b)	R _{th (ch-a)}	208	°C/W

Marking (Note 5)

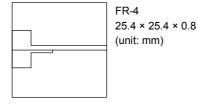


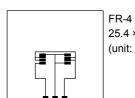
Note 1: Please use devices on condition that the channel temperature is below 150°C.

b)

Note 2:

a) Device mounted on a glass-epoxy board (a)





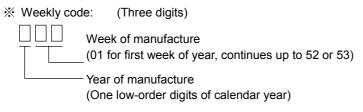
Device mounted on a glass-epoxy board (b)

FR-4 25.4 × 25.4 × 0.8 (unit: mm)

Note 3: V_{DD} = -24 V, T_{ch} = 25°C (initial), L = 1.0 mH, R_G = 25 Ω , I_{AR} = -6.0 A

Note 4: Repetitive rating: pulse width limited by maximum channel temperature

Note 5: O on lower right of the marking indicates Pin 1.

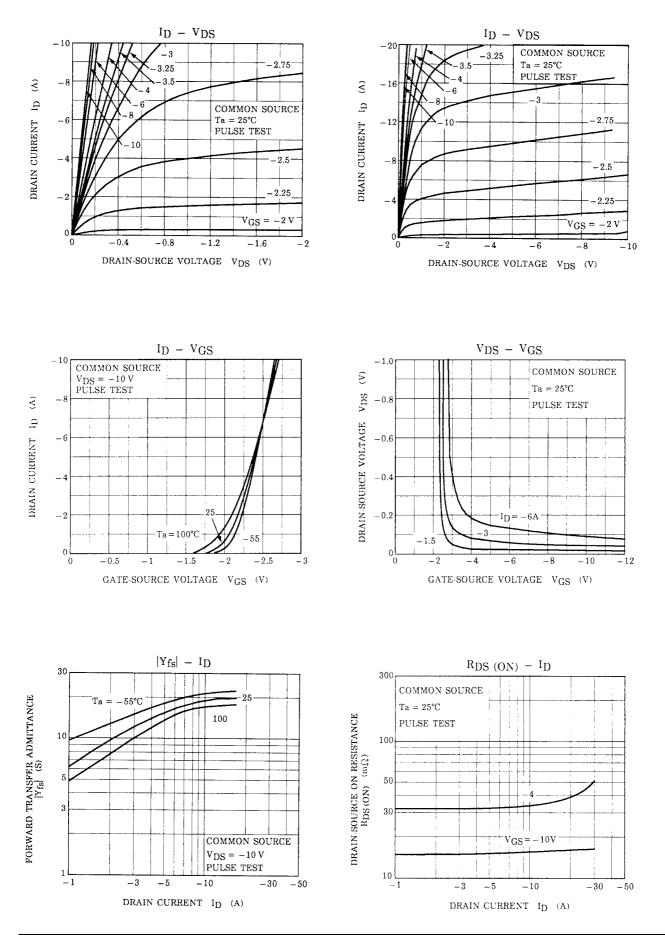


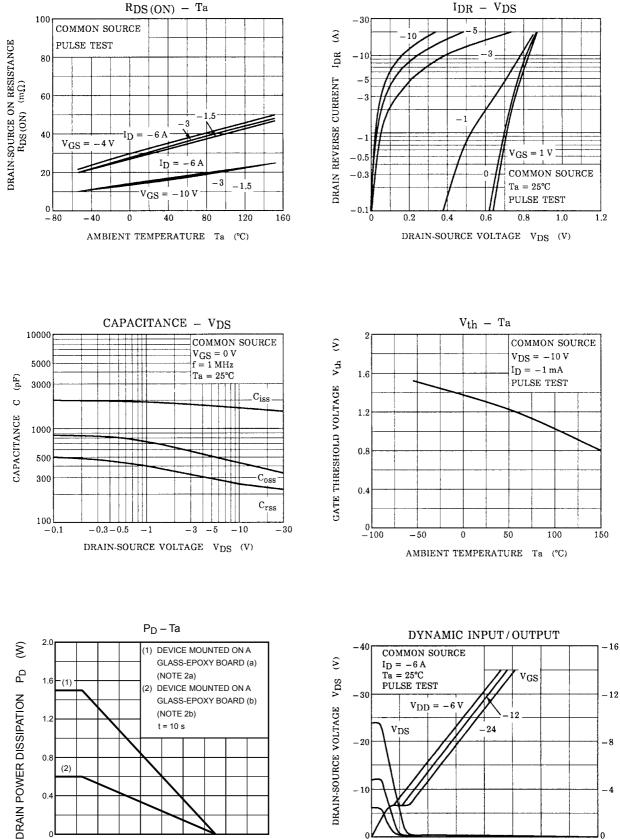
Electrical Characteristics (Ta = 25°C)

Chara	acteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage cur	rrent	I _{GSS}	V_{GS} = ±16 V, V_{DS} = 0 V		—	±10	μA
Drain cut-OFF cu	rrent	I _{DSS}	V_{DS} = -30 V, V_{GS} = 0 V	— — - 10		μA	
Drain-source breakdown voltage		V (BR) DSS	$I_D = -10 \text{ mA}, V_{GS} = 0 \text{ V}$ -30		_		v
		V (BR) DSX	$I_{\rm D}$ = -10 mA, $V_{\rm GS}$ = 20 V	-15 — —		_	v
Gate threshold ve	oltage	V _{th}	$V_{DS} = -10 \text{ V}, \text{ I}_{D} = -1 \text{ mA}$	-0.8 — -2.		-2.0	V
Drain-source ON	resistance	R _{DS (ON)}	$V_{GS} = -4 V, I_D = -3 A$		32	40	mΩ
	Drain-source ON resistance		V_{GS} = -10 V, I _D = -3 A		15	25	mc2
Forward transfer	vard transfer admittance $ Y_{fs} $ $V_{DS} = -10 V$, $I_D = -3 A$		6	12	_	S	
Input capacitance	9	C _{iss}		_	1810	_	pF
Reverse transfer capacitance		C _{rss}	V _{DS} = –10 V, V _{GS} = 0 V, f = 1 MHz	_	350	_	pF
Output capacitance		C _{oss}			610		pF
Switching time	Rise time	tr	$V_{GS} \xrightarrow{0}_{-10} V \xrightarrow{I_D} \xrightarrow{I_D} \xrightarrow{-3} A$ $V_{OUT} \xrightarrow{C} \xrightarrow{C} \xrightarrow{+} \xrightarrow{V} \xrightarrow{V} \xrightarrow{V} \xrightarrow{V} \xrightarrow{V} \xrightarrow{V} \xrightarrow{V} V$	_	9	_	- ns
	Turn-ON time	t _{on}		_	15	_	
	Fall time	t _f			49	—	
	Turn-OFF time	t _{off}		_	135	_	
Total gate charge (gate-source plus gate-drain)		Qg			37	_	nC
Gate-source charge		Q _{gs}	V _{DD} ≈ −24 V, V _{GS} = −10 V, I _D = −6 A	_	30	—	nC
Gate-drain ("miller") charge		Q _{gd}		—	7	_	nC

Source-Drain Ratings and Characteristics (Ta = 25°C)

Charac	ristics Symbol		Test Condition	Min	Тур.	Max	Unit
Drain reverse current	Pulse (Note 1)	I _{DRP}	—	Ι	_	-24	А
Forward voltage	(diode)	de) V_{DSF} I_{DR} = -6 A, V_{GS} = 0 V		_		1.2	V





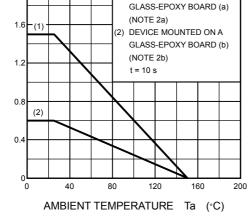
2003-02-20

80

ε

VGS

GATE-SOURCE VOLTAGE



-10

0

0

20

40

TOTAL GATE CHARGE Qg (nC)

60

3

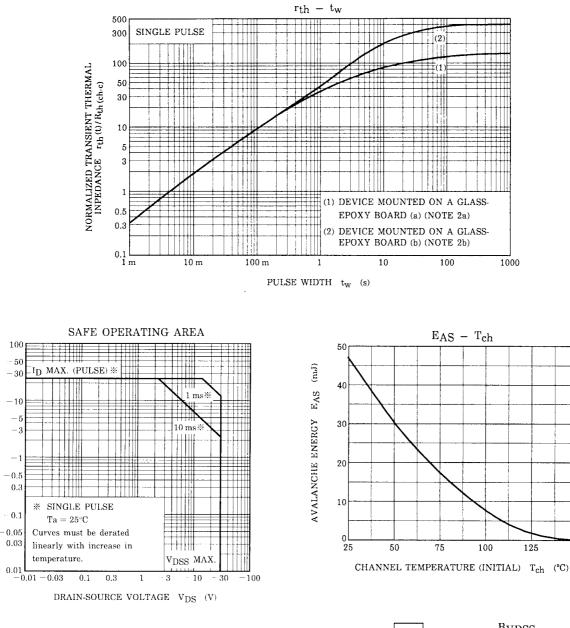
lD

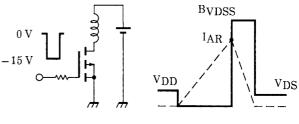
DRAIN CURRENT

1000

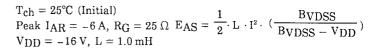
125

150





TEST CIRCUIT WAVE FORM



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